

BUL742C BULB742C

High voltage fast-switching NPN power transistor

Features

- Low spread of dynamic parameters
- High voltage capability
- Minimum lot-to-lot spread for reliable operation
- Very high switching speed

Applications

- Electronic ballast for fluorescent lighting
- Switch mode power supplies



The device is manufactured using high voltage multi-epitaxial planar technology for high switching speeds and high voltage capability. Thanks to an increased intermediate layer, it has an intrinsic ruggedness which enables the transistor to withstand an high collector current level during breakdown condition, without using the transil protection usually necessary in typical converters for lamp ballast.

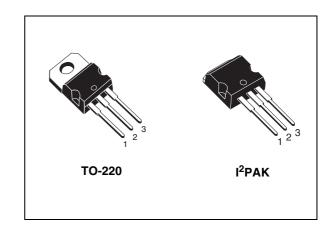


Figure 1. Internal schematic diagram

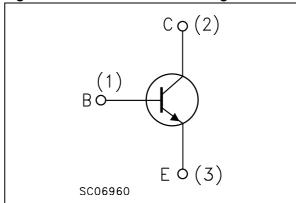


Table 1. **Device summary**

Order code	Marking	Package	Packaging
BUL742C	BUL742C	TO-220	Tuba
BULB742C-1	BULB742C	I ² PAK	Tube

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BUL742C - BULB742C Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum rating

Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{BE} = 0)	1050	V
V _{CEO}	Collector-emitter voltage (I _B = 0)	400	V
V _{EBO}	Emitter-base voltage ($I_C = 0$, $I_B = 2$ A, $t_p < 10$ ms)	V _{(BR)EBO}	V
I _C	Collector current	4	Α
I _{CM}	Collector peak current (t _P < 5ms)	8	Α
I _B	Base current	2	Α
I _{BM}	Base peak current (t _P < 5ms)	4	Α
P _{tot}	Total dissipation at T _c = 25°C	70	W
T _{stg}	Storage temperature	-65 to 150	°C
T _J	Max. operating junction temperature	150	°C

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction - case	1.79	°C/W
R _{thj-amb}	Thermal resistance junction - ambient	62.5	°C/W

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2 Electrical characteristics

 $(T_{case} = 25^{\circ}C \text{ unless otherwise specified})$

Table 4. Electrical characteristics

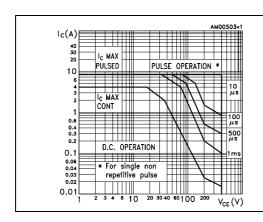
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{CES}	Collector cut-off current (V _{BE} = 0)	V _{CE} =1050 V		0.2	10	μА
I _{CEO}	Collector cut-off current (I _B = 0)	V _{CE} =400 V		10	250	μА
V _{(BR)EBO}	Emitter base breakdown voltage (I _C = 0)	I _E = 1 mA	15	19	24	V
V _{CEO(sus)} (1)	Collector-emitter sustaining voltage (I _B = 0)	I _C =10 mA	400	450		V
V _{CE(sat)} (1)	Collector-emitter saturation voltage	$I_C = 1 \text{ A}$ $I_B = 0.2 \text{ A}$ $I_C = 3.5 \text{ A}$ $I_B = 1 \text{ A}$		0.15 0.6	0.5 1.5	V V
V _{BE(sat)} (1)	Base-emitter saturation voltage	I _C = 3.5 A I _B = 1 A		1.1	1.5	V
h _{FE} ⁽¹⁾	DC current gain	$I_C = 0.1 \text{ A}$ $V_{CE} = 5 \text{ V}$ $I_C = 0.8 \text{ A}$ $V_{CE} = 3 \text{ V}$	48 25	75 35	100 50	
t _s	Resistive load Storage time Fall time	$I_C = 2 \text{ A}$ $V_{CC} = 125 \text{ V}$ $I_{B1} = -I_{B2} = 400 \text{ mA}$ $I_{D} = 300 \mu\text{s}$ $V_{BE(off)} = -5 \text{ V}$		2.4 350	3.5 500	μs ns
E _{ar}	Repetitive avalanche energy	$L = 2 \text{ mH}$ $C = 1.8 \text{ nF}$ $V_{BE(off)} = -5 \text{ V}$	6			mJ

^{1.} Pulsed duration = 300 ms, duty cycle $\le .5\%$

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Derating curve



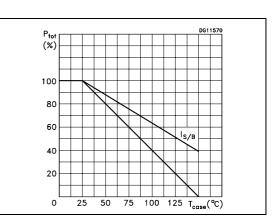
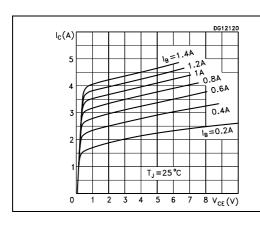


Figure 4. Output characteristics

Figure 5. DC current gain



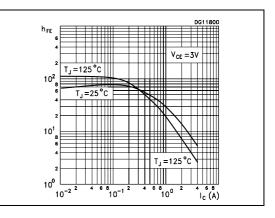
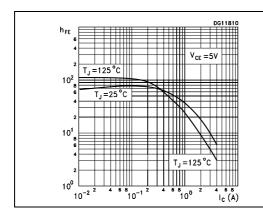
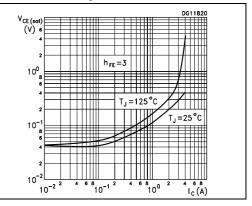


Figure 6. DC current gain

Figure 7. Collector - emitter saturation voltage





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Electrical characteristics BUL742C - BULB742C

Figure 8. Base-emitter saturation voltage

V_{BE(sot)}
(V)
1
0.9
0.8
0.7
0.6
0.5
0.4
0.3
0.2
10⁻²
10⁻²
10⁻¹
10011830

DC11830

T_J = 25 °C

h_{FE} = 3
100 2 4 1c(A)

Figure 9. Resistive load switching on times $(h_{FE} = 5)$

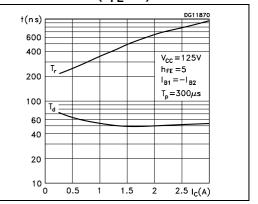


Figure 10. Resistive load switching off times ($h_{FE} = 5$)

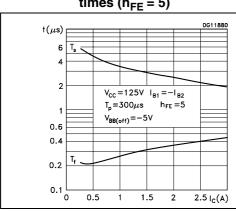


Figure 11. Resistive load switching on times (h_{FE} = 10)

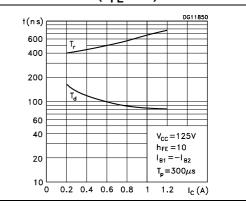


Figure 12. Resistive load switching off times ($h_{FE} = 10$)

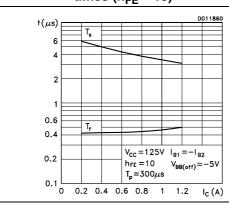
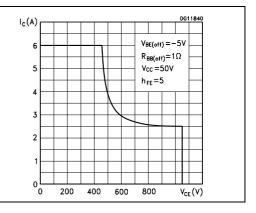


Figure 13. Reverse biased SOA



BUL742C - BULB742C Test circuit

3 Test circuit

Figure 14. Energy rating test circuit

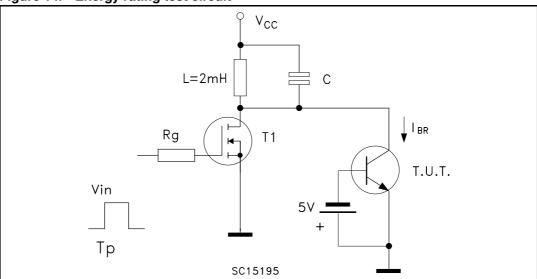
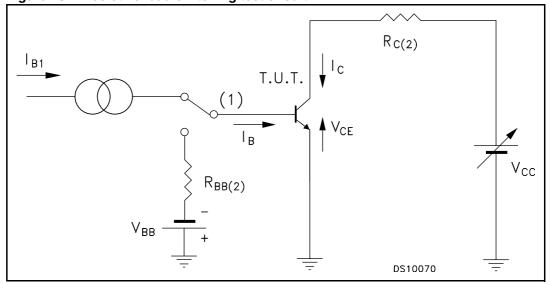


Figure 15. Resistive load switching test circuit



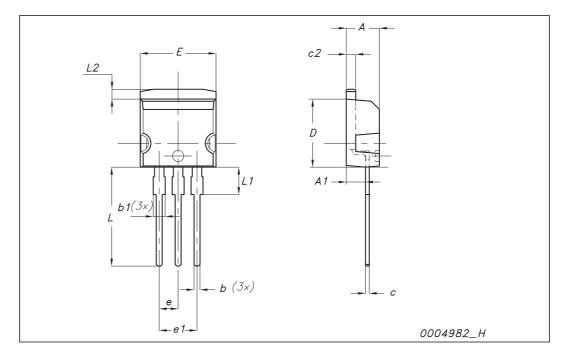
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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

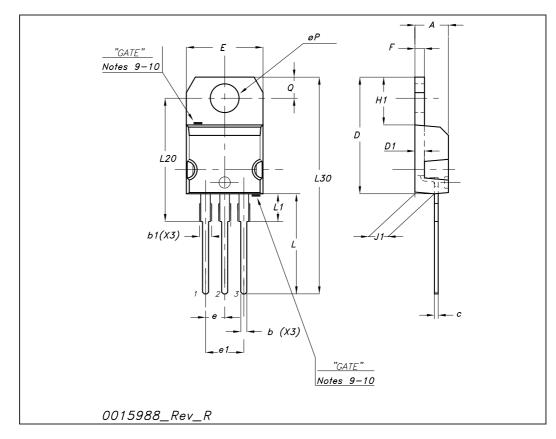
I²PAK (TO-262) mechanical data

Dim	mm			inch		
Dim	Min	Тур	Max	Min	Тур	Max
А	4.40		4.60	0.173		0.181
A1	2.40		2.72	0.094		0.107
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
С	0.49		0.70	0.019		0.027
c2	1.23		1.32	0.048		0.052
D	8.95		9.35	0.352		0.368
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
Е	10		10.40	0.393		0.410
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L2	1.27		1.40	0.050		0.055



TO-220 mechanical data

Dim		mm			inch		
Dim	Min	Тур	Max	Min	Тур	Max	
А	4.40		4.60	0.173		0.181	
b	0.61		0.88	0.024		0.034	
b1	1.14		1.70	0.044		0.066	
С	0.48		0.70	0.019		0.027	
D	15.25		15.75	0.6		0.62	
D1		1.27			0.050		
E	10		10.40	0.393		0.409	
е	2.40		2.70	0.094		0.106	
e1	4.95		5.15	0.194		0.202	
F	1.23		1.32	0.048		0.051	
H1	6.20		6.60	0.244		0.256	
J1	2.40		2.72	0.094		0.107	
L	13		14	0.511		0.551	
L1	3.50		3.93	0.137		0.154	
L20		16.40			0.645		
L30		28.90			1.137	İ	
ØP	3.75		3.85	0.147		0.151	
Q	2.65		2.95	0.104		0.116	



BUL742C - BULB742C Revision history

5 Revision history

Table 5. Document revision history

Date	Revision	Changes	
21-Jun-2004	1	First release	
10-Aug-2007	2	No content changes, document reformatted	
27-May-2008	3	Added package I ² PAK	

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